Silicon Carbide Schottky Diode

650 V, 4 A

FFSB0465A

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

Features

- Max Junction Temperature 175°C
- Avalanche Rated 25 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery
- This Device is Pb-Free, Halogen Free/BFR Free and RoHS Compliant

Applications

- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits

ABSOLUTE MAXIMUM RATINGS

(T_C = 25°C, Unless otherwise specified)

Symbol	Parar	FFSB0465A	Unit	
V_{RRM}	Peak Repetitive Rev	650	V	
E _{AS}	Single Pulse Avaland	che Energy (Note 1)	25	mJ
I _F	Continuous Rectified @ T _C < 160°C	4	Α	
	Continuous Rectified @ T _C < 135°C	7.7		
I _{F, Max}	Non–Repetitive T _C = 25°C, 10 μs		360	Α
	Surge Current	T _C = 150°C, 10 μs	330	
I _{F, SM}	Non-Repetitive Forward Surge Current	Half-Sine Pulse, t _p = 8.3 ms	38	A
I _{F, RM}	Repetitive Forward Surge Current	Half-Sine Pulse, t _p = 8.3 ms	18	Α
P _{tot}	Power Dissipation	T _C = 25°C	63	W
		T _C = 150°C	10.5	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C

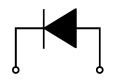
^{1.} E_{AS} of 25 mJ is based on starting $T_J = 25^{\circ}C$, L = 0.5 mH, $I_{AS} = 10$ A, V = 50 V.



ON Semiconductor®

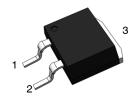
www.onsemi.com

ELECTRICAL CONNECTION



1, 3 Cathode

2. Anode



D²PAK2 (TO-263-2L) CASE 418BK

MARKING DIAGRAM



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code &3 = Numeric Date Code

= Lot Code

FFSB0465A = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

FFSB0465A

THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
$R_{ heta JC}$	Thermal Resistance, Junction to Case, Max.	2.38	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method†	Reel Size	Tape Width	Quantity
FFSB0465A	FFSB0465A	D2PAK	Tape/Reel	N/A	N/A	800 Units

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _F	Forward Voltage	I _F = 4 A, T _C = 25°C	-	1.50	1.75	V
		I _F = 4 A, T _C = 125°C	-	1.6	2.0	
		I _F = 4 A, T _C = 175°C	-	1.72	2.4	
I _R	Reverse Current	V _R = 650 V, T _C = 25°C	-	-	200	μΑ
		V _R = 650 V, T _C = 125°C	-	-	400	
		V _R = 650 V, T _C = 175°C	-	-	600	
Q _C	Total Capacitive Charge	V = 400 V	-	16	-	nC
С	Total Capacitance	V _R = 1 V, f = 100 kHz	-	258	-	pF
		V _R = 200 V, f = 100 kHz	-	29	-	
		V _R = 400 V, f = 100 kHz	-	21	-	

TYPICAL CHARACTERISTICS $T_J = 25^{\circ}C$ Unless Otherwise Noted

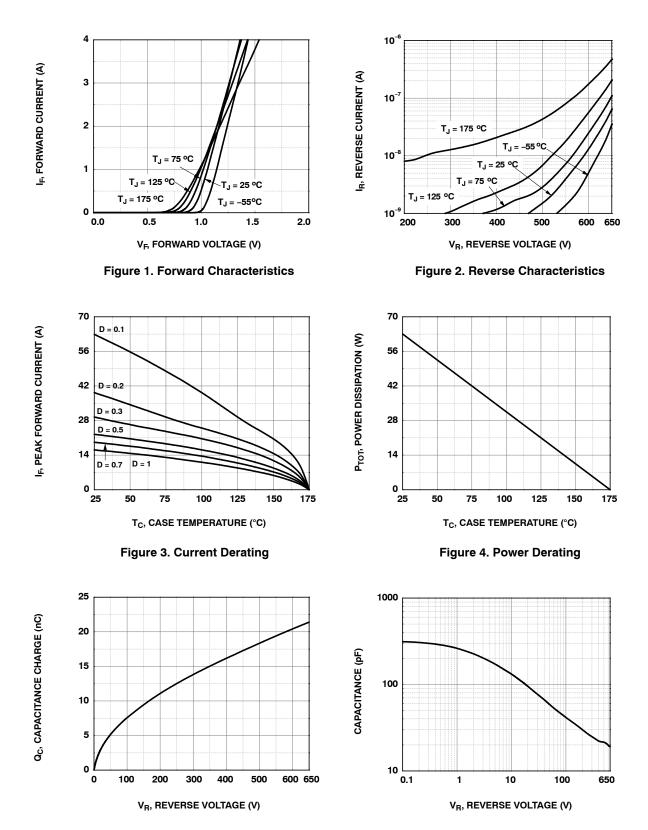


Figure 5. Capacitance Charge vs. Reverse Voltage

Figure 6. Capacitance vs. Reverse Voltage

FFSB0465A

TYPICAL CHARACTERISTICS T_J = 25°C Unless Otherwise Noted (continued)

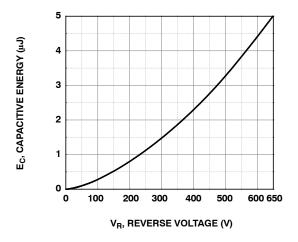


Figure 7. Capacitance Stored Energy

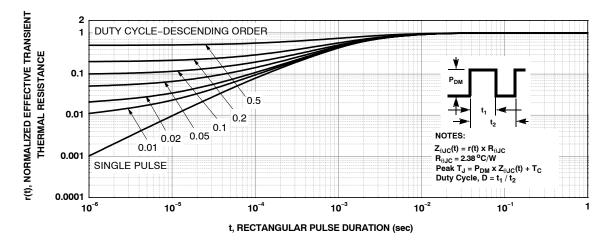


Figure 8. Junction-to-Case Transient Thermal Response Curve

TEST CIRCUIT AND WAVEFORMS

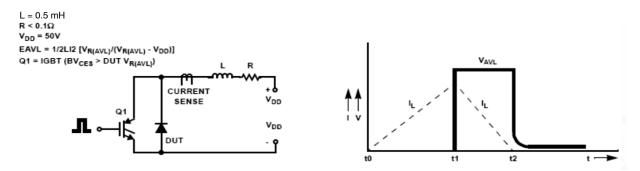
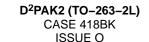
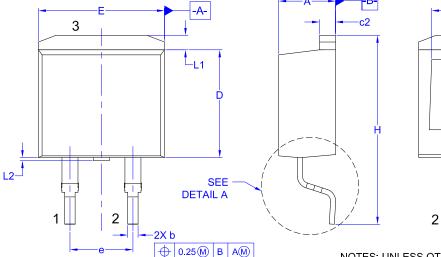
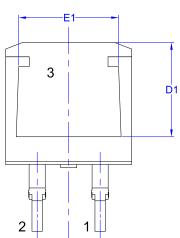


Figure 9. Unclamped Inductive Switching Test Circuit & Waveform



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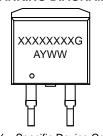


NOTES: UNLESS OTHERWISE SPECIFIED

- A) ALL DIMENSIONS ARE IN MILLIMETERS.
 B) REFERENCE JEDEC, TO-263, VARIATION AB.
- C) DIMENSIONING AND TOLERANCING PER
 DIMENSIONING AND TOLERANCING PER
- ASME Y14.5 2009.
 D) LANDPATTERN RECOMMENDATION PER IPC
- D) LANDPATTERN RECOMMENDATION PER IPO TO254P1524X482-3N

DETAIL A, ROTATED 90°	B)
SCALE: 2X	'(
GAUGE PLANE	D)
M	L3
B 0.10 SEATING —	-A1
GENERIC PLANE	—10.67—— -

GENERIC
MARKING DIAGRAM*



XXX = Specific Device Code

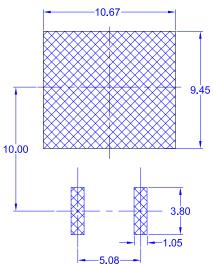
A = Assembly Location

Y = Year

WW = Work Week

G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.



LAND PATTERN RECOMMENDATION
UNLESS NOTED. ALL DIMS TYPICAL

MIN	NOM	MAX
4.06	4.57	4.83
0.00	0.10	0.25
0.51	0.81	0.99
0.30	0.407	0.74
1.14	1.30	1.65
8.38	8.69	9.65
7.30	7.80	8.30
9.65	10.16	10.67
8.00	8.62	9.00
5.08 BSC		
14.60	15.35	15.88
1.78	2.54	2.79
0.90	1.29	1.68
0.00	0.15	0.25
0.25 BSC		
0° 4° 8°		8°
	4.06 0.00 0.51 0.30 1.14 8.38 7.30 9.65 8.00 14.60 1.78 0.90 0.00	4.06 4.57 0.00 0.10 0.51 0.81 0.30 0.407 1.14 1.30 8.38 8.69 7.30 7.80 9.65 10.16 8.00 8.62 5.08 BS 14.60 15.35 1.78 2.54 0.90 1.29 0.00 0.15 0.25 BS

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SS3003CH-TL-E GA01SHT18 CRS10I30A(TE85L,QM MA4E2501L-1290 MBRB30H30CT-1G SB007-03C-TB-E SK32A-TP SK33B-TP
SK38B-TP NRVBM120LT1G NTE505 NTSB30U100CT-1G SS15E-TP VS-6CWQ10FNHM3 ACDBA1100LR-HF ACDBA1200-HF
ACDBA140-HF ACDBA2100-HF ACDBA3100-HF CDBQC0530L-HF ACDBA340-HF ACDBA260LR-HF ACDBA1100-HF SK310B-TP
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